



ALPHA DATA

ADM-PCIE-9H3 User Manual

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Table Of Contents

1	Introduction	1
1.1	Key Features	1
1.2	Order Code	1
2	Board Information	2
2.1	Physical Specifications	2
2.2	Chassis Requirements	3
2.2.1	PCI Express	3
2.2.2	Mechanical Requirements	3
2.2.3	Power Requirements	3
2.3	Thermal Performance	4
2.3.1	Active VS Passive Thermal Management	5
2.4	Customizations	6
3	Functional Description	7
3.1	Overview	7
3.1.1	Switches	8
3.1.2	LEDs	9
3.2	Clocking	10
3.2.1	SI5328	10
3.2.2	PCIe Reference Clocks	11
3.2.3	Fabric Clock	11
3.2.4	Auxiliary Clock	11
3.2.5	Programming Clock (EMCCLK)	11
3.2.6	QSFP-DD	11
3.2.7	Ultraport SlimSAS (OpenCAPI)	11
3.3	PCI Express	12
3.4	QSFP-DD	13
3.5	OpenCAPI Ultraport SlimSAS	14
3.6	System Monitor	15
3.6.1	System Monitor Status LEDs	16
3.6.2	Fan Controllers	16
3.7	USB Interface	17
3.8	Configuration	17
3.8.1	Configuration From Flash Memory	17
3.8.1.1	Building and Programming Configuration Images	18
3.8.2	Configuration via JTAG	18
3.9	GPIO Connector	19
3.9.1	Direct Connect FPGA Signals	19
3.9.2	Timing Input	19
3.10	User EEPROM	20
	Appendix A Complete Pinout Table	21

List of Tables

Table 1	Mechanical Dimensions (PCB only)	2
Table 2	Mechanical Dimensions (Fully Assembled)	2
Table 3	Available Power By Rail	3
Table 4	Switch Functions	8
Table 5	LED Details	9
Table 6	QSFP28 Part Numbers	13
Table 7	Voltage, Current, and Temperature Monitors	15

Table 8	Status LED Definitions	16
Table 9	Complete Pinout Table	21

List of Figures

Figure 1	ADM-PCIE-9H3 Product Photo	1
Figure 2	ADM-PCIE-9H3 Top View	2
Figure 3	Thermal Performance	4
Figure 4	ADM-PCIE-9H3 Fan Plug	5
Figure 5	ADM-PCIE-9H3 Fan Assembly	5
Figure 6	ADM-PCIE-9H3 Baffle	6
Figure 7	ADM-PCIE-9H3 Block Diagram	7
Figure 8	Switches	8
Figure 9	Front Panel LEDs	9
Figure 10	Clock Topology	10
Figure 11	Si5328 Block Diagram	10
Figure 12	QSFP-DD Location	13
Figure 13	OpenCAPI Location	14
Figure 14	GPIO Connector Schematic	19
Figure 15	GPIO Connector Location	19

1 Introduction

The ADM-PCIE-9H3 is a high-performance reconfigurable computing card intended for Data Center applications, featuring a Xilinx Virtex UltraScale+ Plus FPGA with High Bandwidth Memory (HBM).



Figure 1 : ADM-PCIE-9H3 Product Photo

1.1 Key Features

Key Features

- PCIe Gen1/2/3 x1/2/4/8/16 capable
- Passive and active thermal management configuration
- 1/2 length, low profile, x16 edge PCIe form factor
- 8GB HBM on-die memory capable of 460GB/s
- One QSFP-DD cage capable of data rates up to 28 Gbps per 8 channels (224 Gbps)
- One 8 lane Ultraport SlimSAS connectors compliant with OpenCAPI and suitable for IO expansion
- Supports either VU33P or VU35P Virtex UltraScale+ FPGAs
- Front panel and rear edge JTAG access via USB port
- FPGA configurable over USB/JTAG and SPI configuration flash
- Voltage, current, and temperature monitoring
- 8 GPIO signals and 1 isolated timing input

1.2 Order Code

ADM-PCIE-9H3

ADM-PCIE-9H3/NF (without optional fan)

See <http://www.alpha-data.com/pdfs/adm-pcie-9h3.pdf> for complete ordering options.

2 Board Information

2.1 Physical Specifications

The ADM-PCIE-9H3 complies with PCI Express CEM revision 3.0.

Description	Measure
PCB Dy	64.4 mm
PCB Dx	167.65 mm
PCB Dz	1.6 mm

Table 1 : Mechanical Dimensions (PCB only)

Description	Measure
Total Dy	80.1 mm
Total Dx	181.5 mm
Total Dz	19.7 mm
Weight	350 grams

Table 2 : Mechanical Dimensions (Fully Assembled)

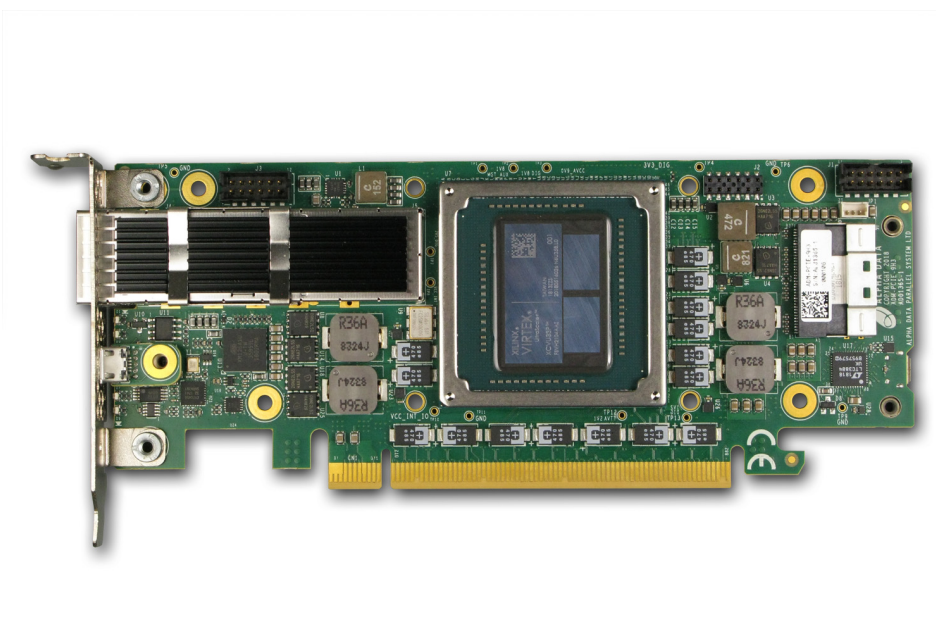


Figure 2 : ADM-PCIE-9H3 Top View

2.2 Chassis Requirements

2.2.1 PCI Express

The ADM-PCIE-9H3 is capable of PCIe Gen 1/2/3 with 1/2/4/8/16 lanes, using the Xilinx Integrated Block for PCI Express.

2.2.2 Mechanical Requirements

A 16-lane physical PCIe slot is required for mechanical compatibility.

2.2.3 Power Requirements

The ADM-PCIE-9H3 draws all power from the PCIe Edge. As per PCIe specification, this limits the power consumption of the card to a maximum 75W.

Power consumption estimation requires the use of the Xilinx XPE spreadsheet and a power estimator tool available from Alpha Data. Please contact support@alpha-data.com to obtain this tool.

The power available to the rails calculated using XPE are as follows:

Voltage	Source Name	Current Capability
0.72-0.90	VCC_INT + VCCINT_IO + VCC_BRAM	42A
0.9	MGTAVCC	5A
1.2	MGTAVTT	9A
1.2	VCC_HBM * VCC_IO_HBM	14A
1.8	VCCAUX + VCCAUX_IO + VCCO_1.8V	1.5A
1.8	MGTVCCAUX	0.5A
2.5	VCCAUX_HBM	2.2A
3.3	3.3V for Optics	3.6A

Table 3 : Available Power By Rail

2.3 Thermal Performance

If the FPGA core temperature exceeds 105 degrees Celsius, the FPGA design will be cleared to prevent the card from over-heating.

The ADM-PCIE-9H3 comes with a heat sink to reduce the temperature of the FPGA, which is typically the hottest point on the card. The FPGA die temperature must remain under 100 degrees Celsius. To calculate the FPGA die temperature, take your application power, multiply by Theta JA from the table below, and add to your system internal ambient temperature. The graph below shows two lines, one was tested in a duct with the shrouds installed, and the other was tested without the shrouds. The performance is generally better without the shrouds, but they do provide improved handling and reduce air re-circulation in compact servers. The shroud can be removed using a 1/16" hex driver. If you are using the fan provided with the board, you will find theta JA is approximately 1.43 degC/W for the board in still air with or without the shroud installed.

The power dissipation can be estimated by using the Alpha Data power estimator in conjunction with the Xilinx Power Estimator (XPE) downloadable at <http://www.xilinx.com/products/technology/power/xpe.html>. Download the UltraScale tool and set the device to Virtex UltraScale+, VU33P, FSVH2104, -2, -2L, or -3, extended. Set the ambient temperature to your system ambient and select 'user override' for the effective theta JA and enter the figure associated with your system LFM in the blank field. Proceed to enter all applicable design elements and utilization in the following spreadsheet tabs. Next acquire the 9H3 power estimator from Alpha Data by contacting support@alpha-data.com. You will then plug in the FPGA power figures along with Optical module figures to get a board level estimate.

ADM-PCIE-9H3 Board Level Thermal Performance

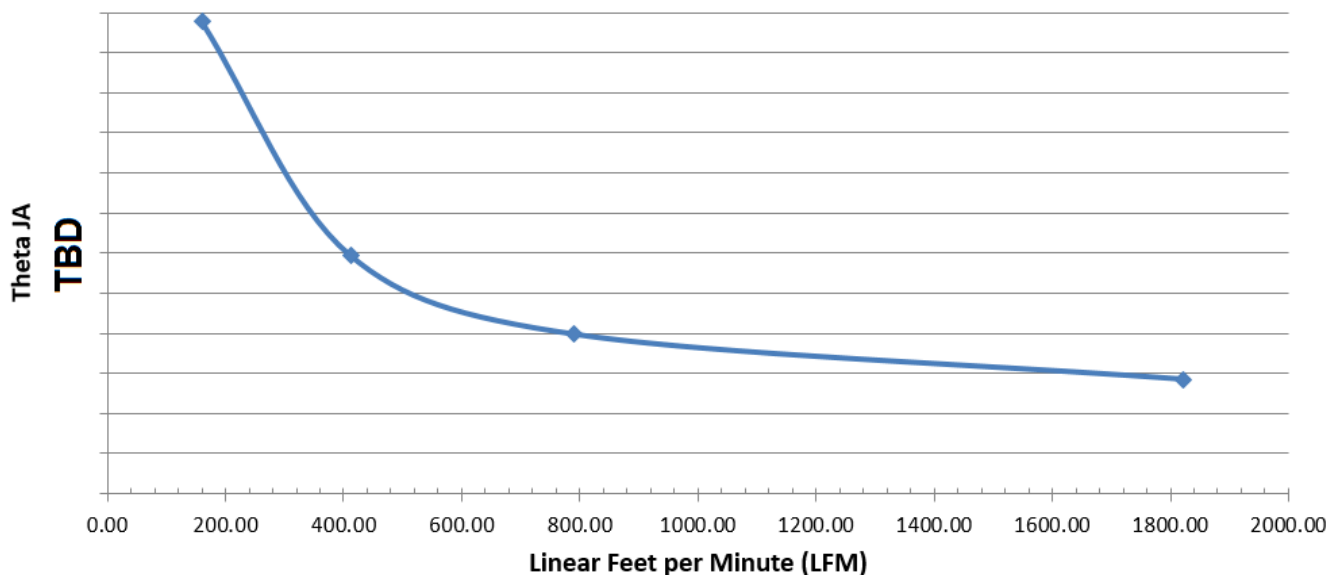


Figure 3 : Thermal Performance

2.3.1 Active VS Passive Thermal Management

The ADM-PCIE-9H3 ships with a small optional blower for active cooling in systems with poor airflow. If the ADM-PCIE-9H3 will be installed in a server with controlled airflow, the order option /NF can be used to receive cards without this extra piece. The fans have a much shorter mean time between failure (MTBF) than the rest of the assembly, so passive cards have much longer life expectancy before requiring maintenance. The ADM-PCIE-9H3 also includes a fan speed controller, allowing variable fan speed based on die temperature, and detection of a failed fan (see section [Fan Controllers](#)).

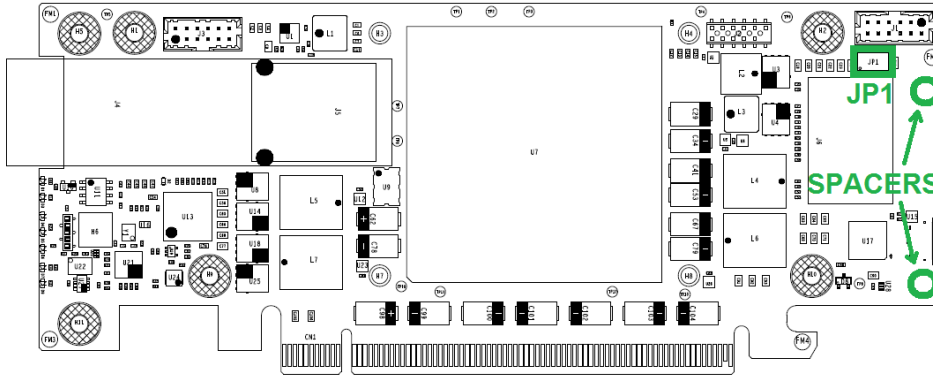


Figure 4 : ADM-PCIE-9H3 Fan Plug

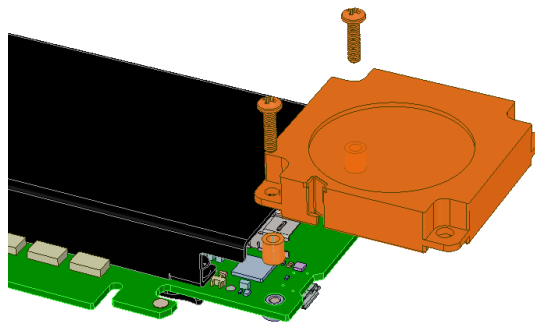


Figure 5 : ADM-PCIE-9H3 Fan Assembly

2.4 Customizations

Alpha Data provides extensive customization options to existing commercial off-the-shelf (COTS) products. Some options include, but are not limited to: additional networking cages in adjacent slots or full profile, enhanced heat sinks, baffles, and circuit additions.

Please contact sales@alpha-data.com to get a quote and start your project today.

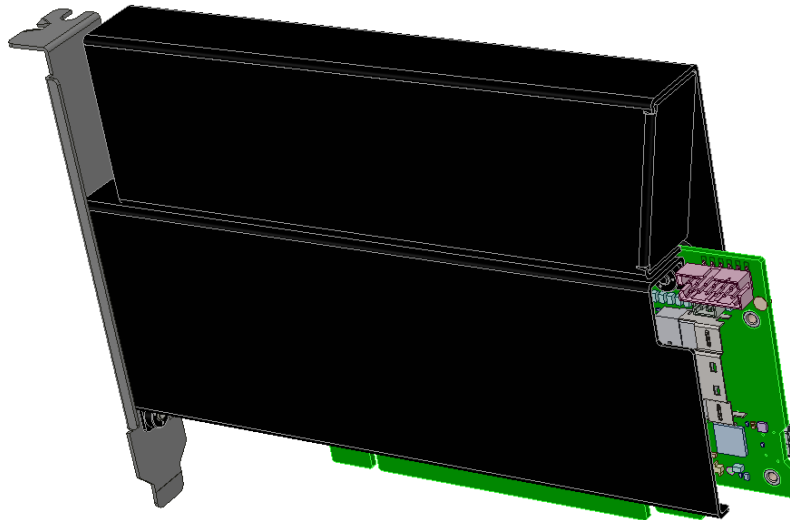


Figure 6 : ADM-PCIE-9H3 Baffle

3 Functional Description

3.1 Overview

The ADM-PCIE-9H3 is a versatile reconfigurable computing platform with a Virtex UltraScale+ VU33P/VU35P FPGA, a Gen3x16 PCIe interface, 8GB of HBM memory, one QSFP-DD cage, an OpenCAPI compatible Ultraport SlimSAS connector also capable of 28G/channel, an isolated input for a timing synchronization pulse, a 12 pin header for general purpose use (clocking, control pins, debug, etc.), front panel LEDs, and a robust system monitor.

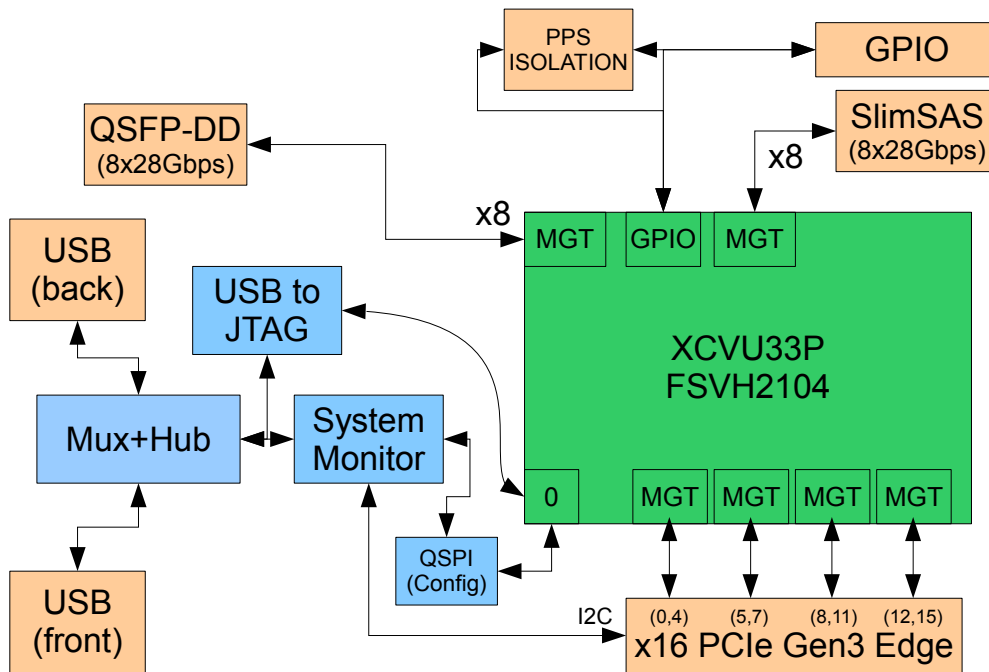


Figure 7 : ADM-PCIE-9H3 Block Diagram

3.1.1 Switches

The ADM-PCIE-9H3 has an octal DIP switch SW1, located on the rear side of the board. The function of each switch in SW1 is detailed below:

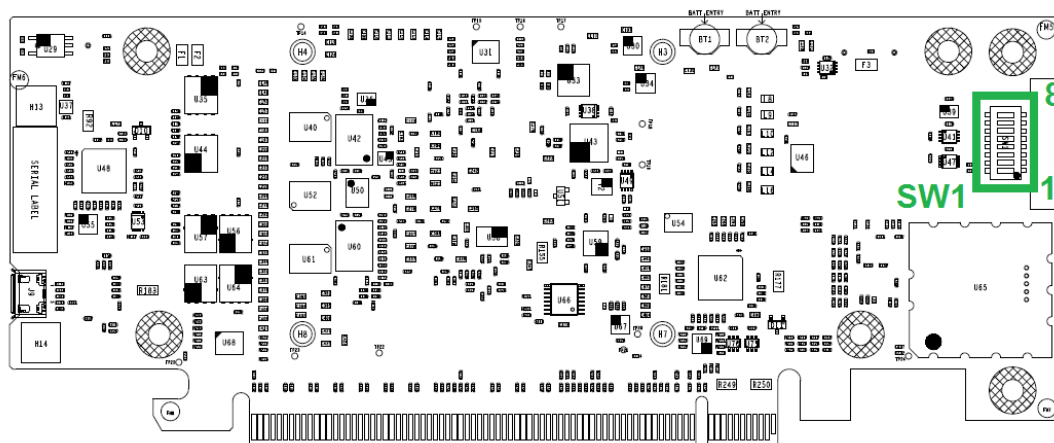


Figure 8 : Switches

Switch	Factory Default	Function	OFF State	ON State
SW1-1	OFF	User Switch 0	Pin AW33 = '1'	Pin BF52 = '0'
SW1-2	OFF	User Switch 1	Pin AY36 = '1'	Pin BF47 = '0'
SW1-3	OFF	Reserved	Reserved	Reserved
SW1-4	OFF	Power Off	Board will power up	Immediately power down
SW1-5	OFF	Service Mode	Regular Operation	Firmware update service mode
SW1-6	ON	HOST_I2-C_EN	Sysmon over PCIe I2C	Sysmon isolated
SW1-7	ON	CAPI_VP-D_EN	OpenCAPI VPD available	OpenCAPI VPD isolated
SW1-8	ON	CAPI_VP-D_WP	CAPI VPD is write protected	CAPI VPD is writable

Table 4 : Switch Functions

Use IO Standard "LVCMOS18" when constraining the user switch pins.

3.1.2 LEDs

There are 7 LEDs on the ADM-PCIE-9H3, 4 of which are general purpose and whose meaning can be defined by the user. The other 3 have fixed functions described below:

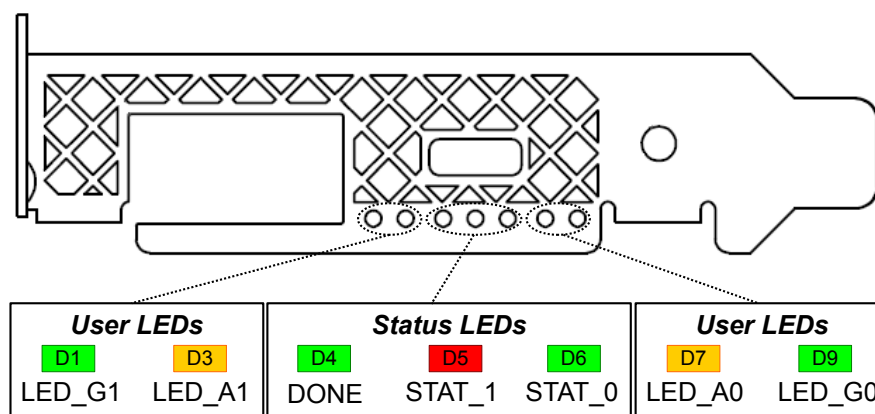


Figure 9 : Front Panel LEDs

Comp. Ref.	Function	ON State	OFF State
D1	LED_G1	User defined '0'	User defined '1'
D3	LED_A1	User defined '0'	User defined '1'
D4	DONE	FPGA is configured	FPGA is not configured
D5	Status 1	See Status LED Definitions	
D6	Status 0	See Status LED Definitions	
D7	LED_A0	User defined '0'	User defined '1'
D9	LED_G0	User defined '0'	User defined '1'

Table 5 : LED Details

See Section [Complete Pinout Table](#) for full list of user controlled LED nets and pins

3.2 Clocking

The ADM-PCIE-9H3 provides flexible reference clock solutions for the many multi-gigabit transceiver quads and FPGA fabric. Any clock out of the Si5338 Clock Synthesizer is re-configurable from either the front panel USB [USB Interface](#) or the Alpha Data sysmon FPGA serial port. This allows the user to configure almost any arbitrary clock frequency during application run time. Maximum clock frequency is 312.5MHz.

There is also an available Si5328 jitter attenuator. This can provide clean and synchronous clocks to the QSFP-DD and OpenCAPI (SlimSAS) quad locations at many clock frequencies. These devices only use volatile memory, so the FPGA design will need to re-configure the register map after any power cycle event.

All clock names in the section below can be found in [Complete Pinout Table](#).

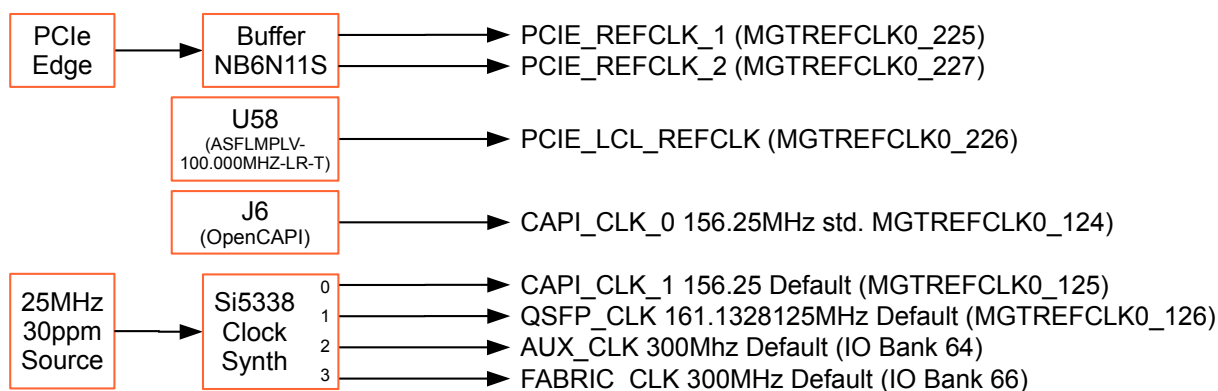


Figure 10 : Clock Topology

3.2.1 Si5328

If jitter attenuation is required please see the reference documentation for the Si5328. <https://www.silabs.com/Support%20Documents/TechnicalDocs/Si5328.pdf>

The circuit connections mirror Xilinx VCU110 and VCU108, please see Xilinx Dev Boards for references.

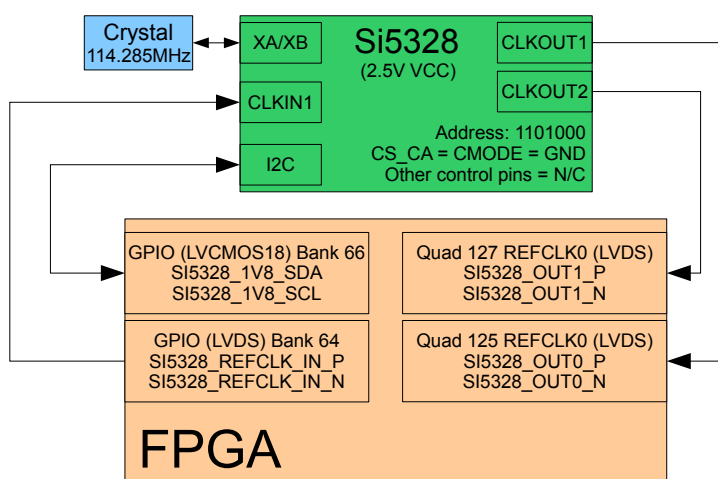


Figure 11 : Si5328 Block Diagram

3.2.2 PCIe Reference Clocks

The 16 MGT lanes connected to the PCIe card edge use MGT tiles 224 through 227 and use the system 100 MHz clock (net name PCIE_REFCLK).

Alternatively, a clean, onboard 100MHz clock is available as well (net name PCIE_LCL_REFCLK).

3.2.3 Fabric Clock

The design offers a fabric clock (net name FABRIC_SRC_CLK) which defaults to 300 MHz. This clock is intended to be used for IDELAY elements in FPGA designs. The fabric clock is connected to a Global Clock (GC) pin.

DIFF_TERM_ADV = TERM_100 is required for LVDS termination

3.2.4 Auxiliary Clock

The design offers a auxiliary clock (net name AUX_CLK) which defaults to 300 MHz. This clock can be used for any purpose and is connected to a Global Clock (GC) pin.

DIFF_TERM_ADV = TERM_100 is required for LVDS termination

3.2.5 Programming Clock (EMCCLK)

A 100MHz clock (net name EMCCLK_B) is fed into the EMCCLK pin to drive the SPI flash device during configuration of the FPGA. Note that this is not a global clock capable IO pin.

3.2.6 QSFP-DD

The QSFP-DD cage is located in MGT tiles 126 and 127 and use a 161.1328125MHz default reference clock. Note that this clock frequency can be changed to any arbitrary clock frequency up to 312MHz by re-programing the Si5338 reprogrammable clock oscillator via system monitor. This can be done using the Alpha Data API or over USB with the appropriate Alpha Data Software tools.

See net names QSFP_CLK* for pin locations.

The QSFP-DD cage is also located such that it can be clocked from the Si5328 jitter attenuator clock multiplier.

See net names SI5328_OUT_1* for pin locations.

3.2.7 Ultraport SlimSAS (OpenCAPI)

The Ultraport SlimSAS connector is located in MGT tile 124 and 125.

For OpenCAPI an external 156.25MHz clock is provided over the cable. See net names CAPI_CLK_0* for cable clock pin locations.

Another alternative clock source for this interface is the Si5338 clock synthesizer which is defaulted to 161.1328125MHz. See net names CAPI_CLK_1* for pin locations. Note that this clock frequency can be changed to any arbitrary clock frequency up to 312MHz by re-programing the Si5338 reprogrammable clock oscillator via system monitor. This can be done using the Alpha Data API or over USB with the appropriate Alpha Data Software tools.

For jitter sensitive applications, this interface can be clocked from the Si5328 jitter attenuator. See net names SI5328_OUT_0* for pin locations.

3.3 PCI Express

The ADM-PCIE-9H3 is capable of PCIe Gen 1/2/3 with 1/2/4/8/16 lanes. The FPGA drives these lanes directly using the Integrated PCI Express block from Xilinx. Negotiation of PCIe link speed and number of lanes used is generally automatic and does not require user intervention.

PCI Express reset (PERST#) connected to the FPGA at two location. See [Complete Pinout Table](#) signals PERST0_1V8_L and PERST1_1V8_L.

The other pin assignments for the high speed lanes are provided in the pinout attached to the [Complete Pinout Table](#)

The PCI Express specification requires that all add-in cards be ready for enumeration within 120ms after power is valid (100ms after power is valid + 20ms after PERST is released). The ADM-PCIE-9H3 does meet this requirement when configured from a tandem bitstream with the proper SPI constraints detailed in the section: Configuration From Flash Memory. For more details on tandem configuration, see Xilinx xapp 1179.

Note:

Different motherboards/backplanes will benefit from different RX equalization schemes within the PCIe IP core provided by Xilinx. Alpha Data recommends using the following setting if a user experiences link errors or training issues with their system: within the IP core generator, change the mode to "Advanced" and open the "GT Settings" tab, change the "form factor driven insertion loss adjustment" from "Add-in Card" to "Chip-to-Chip" (See Xilinx PG239 for more details).

3.4 QSFP-DD

One QSFP-DD cage is available at the front panel. This cage is capable of housing either QSFP28 or QSFP-DD cables (backwards compatible). Both active optical and passive copper QSFP-DD/QSFP28 compatible models are fully compliant. The communication interface can run at up to 28Gbps per channel. There are 8 channels across the QSFP-DD cage (total maximum bandwidth of 224Gbps). This cage is ideally suited for 8x 10G/25G, 2x 100G Ethernet, or any other protocol supported by the Xilinx GTY Transceivers. Please see Xilinx User Guide UG578 for more details on the capabilities of the transceivers.

The QSFP-DD cage has control signals connected to the FPGA. The connectivity is detailed in the [Complete Pinout Table](#) at the end of this document. The notation used in the pin assignments is QSFP* with locations clarified in the diagram below.

Use the QSFP_SCL_1V8 and QSFP_SDA_1V8 pins as detailed in [Complete Pinout Table](#) to communicate with QSFP28 register space.

Note:

The LP_MODE (Low Power Mode) to the cage is tied to ground, use the management interface to set power rules.

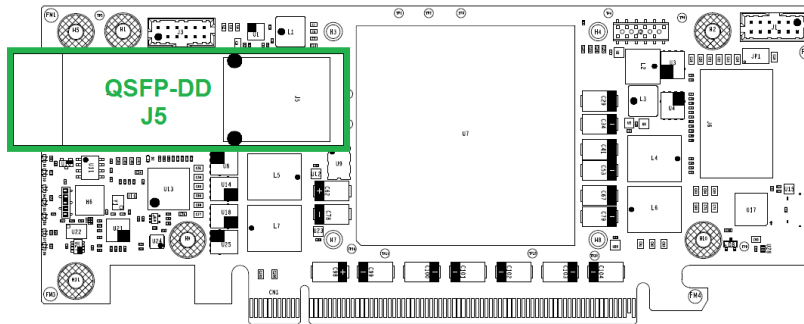


Figure 12 : QSFP-DD Location

It is possible for Alpha Data to pre-fit the ADM-PCIE-9H3 with QSFP-DD and QSFP28 components. The table below shows the part number for the transceivers fitted when ordered with this board.

Order Code	Description	Part Number	Manufacturer
Q10	40G (4x10) QSFP Optical Transceiver	FTL410QE2C	Finisar
Q14	56G (4x14) QSFP Optical Transceiver	FTL414QB2C	Finisar
Q25	100G (4x25) QSFP28 Optical Transceiver	FTLC9558REPM	Finisar

Table 6 : QSFP28 Part Numbers

3.5 OpenCAPI Ultraport SlimSAS

An Ultraport SlimSAS receptacles along the back of the board allow for OpenCAPI compliant interfaces running at 200G (8 channels at 25G). Please contact support@alpha-data.com or your IBM representative for more details on OpenCAPI and its benefits.

The SlimSAS connector can also be used to connect an additional 2x QSFP28 breakout board, contact sales@alpha-data.com for more details. Alternatively, cabling can be used to connect multiple ADM-PCIE-9H3 cards within a chassis.

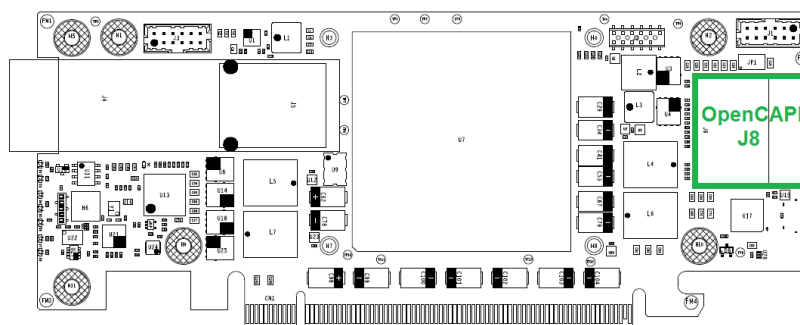


Figure 13 : OpenCAPI Location

3.6 System Monitor

The ADM-PCIE-9H3 has the ability to monitor temperature, voltage, and current of the system to check on the operation of the board. The monitoring is implemented using an Atmel AVR microcontroller.

If the core FPGA temperature exceeds 105 degrees Celsius, the FPGA will be cleared to prevent damage to the card.

Control algorithms within the microcontroller automatically check line voltages and on board temperatures and shares makes the information available to the FPGA over a dedicated serial interface built into the Alpha Data reference design package (sold separately). The information can also be accessed directly from the microcontroller over the USB interface on the front panel or via the IPMI interface available at the PCIe card edge.

Monitors	Index	Purpose/Description
ETC	ETC	Elapsed time counter (seconds)
EC	EC	Event counter (power cycles)
12V	ADC00	Board input supply
12V_I	ADC01	12V input current in amps
3.3V	ADC02	Board input supply
3.3V_I	ADC03	3.3V input current in amps
3.3V	ADC05	Board input auxiliary power
3.3V	ADC05	3.3V for QSFP optics
2.5V	ADC06	Clock and DRAM voltage supply
1.8V	ADC07	FPGA IO voltage (VCCO)
1.8V	ADC08	Transceiver power (AVCC_AUX)
1.2V	ADC09	HBM Power
1.2V	ADC10	Transceiver Power (AVTT)
0.9V	ADC11	Transceiver Power (AVCC)
0.85-0.90V	ADC12	BRAM + INT_IO (VccINT_IO)
0.72-0.90V	ADC13	FPGA Core Supply (VccINT)
uC_Temp	TMP00	FPGA on-die temperature
Board0_Temp	TMP01	Board temperature near front panel
Board1_Temp	TMP02	Board temperature near back top corner
FPGA_Temp	TMP03	FPGA on-die temperature

Table 7 : Voltage, Current, and Temperature Monitors

3.6.1 System Monitor Status LEDs

LEDs D5 (Red) and D6 (Green) indicate the card health status.

LEDs	Status
Green	Running and no alarms
Green + Red	Standby (Powered off)
Flashing Green + Flashing Red (together)	Attention - critical alarm active
Flashing Green + Flashing Red (alternating)	Service Mode
Flashing Green + Red	Attention - alarm active
Red	Missing application firmware or invalid firmware
Flashing Red	FPGA configuration cleared to protect board

Table 8 : Status LED Definitions

3.6.2 Fan Controllers

The onboard USB bus controlled by the system monitor has access to a MAX6620 fan controller. This device can be controlled through the multiple onboard system monitor communication interfaces, including USB, PCIe Edge SMBUS, and FPGA sysmon serial communication port. The fan controller is on I2C bus 1 at address 0x2a. For additional questions. Contact support@alpha-data.com with additional questions on utilizing these controllers.

3.7 USB Interface

The FPGA can be configured directly from the USB connection on either the front panel or the rear card edge. The ADM-PCIE-9H3 utilizes the Digilent USB-JTAG converter box which is supported by the Xilinx software tool suite. Simply connect a micro-USB AB type cable between the ADM-PCIE-9H3 USB port and a host computer with Vivado installed. Vivado Hardware Manager will automatically recognize the FPGA and allow you to configure the FPGA and the SBPI configuration PROM.

The same USB connector is used to directly access the system monitor system. All voltages, currents, temperatures, and non-volatile clock configuration settings can be accessed using Alpha Data's avr2util software at this interface.

Avr2util for Windows and the associated USB driver is downloadable here:

<https://support.alpha-data.com/pub/firmware/utilities/windows/>

Avr2util for Linux is downloadable here:

<https://support.alpha-data.com/pub/firmware/utilities/linux/>

Use "avr2util.exe /?" to see all options.

For example "avr2util.exe /usbcom com4 display-sensors" will display all sensor values.

For example "avr2util.exe /usbcom com4 setclknv 1 156250000" will set the QSFP clock to 156.25MHz. setclk index 0 = CAPI_CLK_1, index 1 = QSFP_CLK, index 2 = AUX_CLK, index 3 = FABRIC_CLK.

Change 'com4' to match the com port number assigned under windows device manager.

3.8 Configuration

There are two main ways of configuring the FPGA on the ADM-PCIE-9H3:

- From Flash memory, at power-on, as described in [Section 3.8.1](#)
- Using USB cable connected at either USB port [Section 3.8.2](#)

3.8.1 Configuration From Flash Memory

The FPGA can be automatically configured at power-on from two 256 Mbit QSPI flash memory device configured as an x8 SPI device (Micron part numbers MT25QU256ABA8E12-0). These flash devices are typically divided into two regions of 32 MiByte each, where each region is sufficiently large to hold an uncompressed bitstream for a VU33P FPGA.

The ADM-PCIE-9H3 is shipped with a simple PCIe endpoint bitstream containing a basic Alpha Data ADXDMA bitstream. Alpha Data can load in other custom bitstreams during production test, please contact sales@alpha-data.com for more details.

It is possible to use Multiboot with a fallback image on this hardware. The master SPI configuration interface and the Fallback MultiBoot are discussed in detail in Xilinx UG570.

At power-on, the FPGA attempts to configure itself automatically in serial master mode based on the contents of the header in the programming file. Multiboot and ICAP can be used to selected between the two configuration regions to be loaded into the FPGA. See Xilinx UG570 MultiBoot for details.

The image loaded can also support tandem PROM or tandem PCIe with field update configuration methods. These options reduce power-on load times to help meet the PCIe reset timing requirements. Tandem with field also enables a host system to reconfigure the user FPGA logic without losing the PCIe link, a useful feature when system resets and power cycles are not an option.

The Alpha Data System Monitor is also capable of reconfiguring the flash memory and reprogramming the FPGA. This provides a useful failsafe mechanism to re-program the FPGA even if it drops off the PCIe bus. The system monitor can be accessed over USB at the front panel and rear edge, or over the SMBUS connections on the

PCIe edge.

3.8.1.1 Building and Programming Configuration Images

Generate a bitfile with these constraints (see xapp1233):

- `set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]`
- `set_property BITSTREAM.CONFIG.EXTMASTERCLK_EN {DIV-1} [current_design]`
- `set_property BITSTREAM.CONFIG.SPI_32BIT_ADDR YES [current_design]`
- `set_property BITSTREAM.CONFIG.SPI_BUSWIDTH 8 [current_design]`
- `set_property BITSTREAM.CONFIG.SPI_FALL_EDGE YES [current_design]`
- `set_property BITSTREAM.CONFIG.UNUSEDPIN {Pullnone} [current_design]`
- `set_property CFGBVS GND [current_design]`
- `set_property CONFIG_VOLTAGE 1.8 [current_design]`
- `set_property BITSTREAM.CONFIG.OVERTEMPSHUTDOWN Enable [current_design]`

Generate an MCS file with these properties (write_cfgmem):

- `-format MCS`
- `-size 64`
- `-interface SPIx8`
- `-loadbit "up 0x0000000 <directory/to/file/filename.bit>" (0th location)`
- `-loadbit "up 0x2000000 <directory/to/file/filename.bit>" (1st location, optional)`

Program with vivado hardware manager with these settings (see xapp1233):

- SPI part: mt25qu256-spi-x1_x2_x4_x8
- State of non-config mem I/O pins: Pull-none
- Target the four files generated from the write_cfgmem tcl command.

3.8.2 Configuration via JTAG

A micro-USB AB Cable may be attached to the front panel or rear edge USB port. This permits the FPGA to be reconfigured using the Xilinx Vivado Hardware Manager via the integrated Digilent JTAG converter box. The device will be automatically recognized in Vivado Hardware Manager.

For more detailed instructions, please see "Using a Vivado Hardware Manager to Program an FPGA Device" section of Xilinx UG908: https://www.xilinx.com/support/documentation/sw_manuals/xilinx2014_1/ug908-vivado-programming-debugging.pdf

3.9 GPIO Connector

The GPIO option consists of a versatile shrouded connector from Molex with part number 87832-1222 that give users with custom IO requirements four direct connect to FPGA signals.

Recommended mating plug: Molex 0875681273 or 0511101260

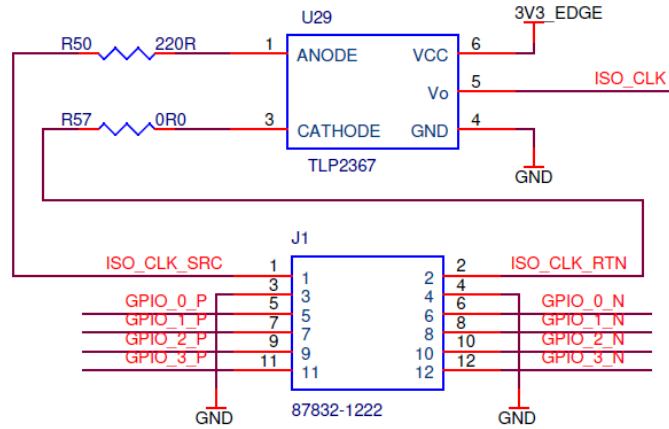


Figure 14 : GPIO Connector Schematic

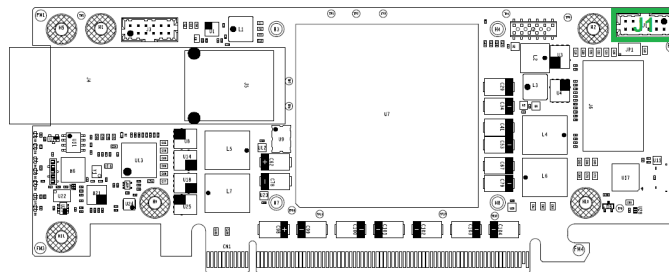


Figure 15 : GPIO Connector Location

3.9.1 Direct Connect FPGA Signals

8 nets are broken out to the GPIO header, as four sets of differential pairs. These signal are suitable for any 1.8V supported signaling standards supported by the Xilinx UltraScale architecture. See Xilinx UG571 for IO options. LVDS and 1.8 CMOS are popular options. The 0th GPIO signal index is suitable for a global clock connection.

The direct connect GPIO signals are limited to 1.8V by a quickswitch (74CBTLVD3245PW) in order to protect the FPGA from overvoltage on IO pins. This quickswitch allows the signals to travel in either direction with only 4 ohms of series impedance and less than 1ns of propagation delay. The nets are directly connected to the FPGA after the quickswitch.

Direct connect signal names are labeled GPIO_0_1V8_P/N and GPIO_1_1V8_P/N, etc. to show polarity and grouping. The signal pin allocations can be found in [Complete Pinout Table](#)

3.9.2 Timing Input

J1.1 and J1.2 can be used as an isolated timing input signal (up to 25MHz). Applications can either directly connect to the GPIO connector, or Alpha Data can provide a cabled solution with an SMA or similar connector on the front panel. Contact sales@alpha-data.com for front panel connector options.

For pin locations, see signal name ISO_CLK in [Complete Pinout Table](#).

The signal is isolated through an optical isolator part number TLP2367 with a 220 ohm of series resistance.

3.10 User EEPROM

A 2Kb I2C user EEPROM is provided for storing MAC addresses or other user information. The EEPROM is part number CAT34C02HU4IGT4A

The address pins A2, A1, and A0 are all strapped to a logical '0'.

Write protect (WP), Serial Clock (SCL), and Serial Data (SDA) pin assignments can be found in [Complete Pinout Table](#) with the names SPARE_WP, SPARE_SCL, and SPARE_SDA respectively.

WP, SDA, and SCL signals all have external pull-up resistors on the card.

Appendix A: Complete Pinout Table

Pin Number	Signal Name	Pin Name	Bank Voltage
BC18	AUX_CLK_PIN_N	IO_L11N_T1U_N9_GC_64	1.8 (LVCMOS18)
BB18	AUX_CLK_PIN_P	IO_L11P_T1U_N8_GC_64	1.8 (LVCMOS18)
BF33	AVR_B2U_1V8	IO_L2P_T0L_N2_66	1.8 (LVCMOS18)
BF31	AVR_HS_B2U_1V8	IO_L1P_T0L_N0_DBC_66	1.8 (LVCMOS18)
BB33	AVR_HS_CLK_1V8	IO_L12N_T1U_N11_GC_66	1.8 (LVCMOS18)
BF32	AVR_HS_U2B_1V8	IO_L1N_T0L_N1_DBC_66	1.8 (LVCMOS18)
BA33	AVR_MON_CLK_1V8	IO_L12P_T1U_N10_GC_66	1.8 (LVCMOS18)
BF34	AVR_U2B_1V8	IO_L2N_T0L_N3_66	1.8 (LVCMOS18)
AK39	CAPI_CLK_0_PIN_N	MGTREFCLK0N_124	MGT REFCLK
AK38	CAPI_CLK_0_PIN_P	MGTREFCLK0P_124	MGT REFCLK
AF39	CAPI_CLK_1_PIN_N	MGTREFCLK0N_125	MGT REFCLK
AF38	CAPI_CLK_1_PIN_P	MGTREFCLK0P_125	MGT REFCLK
BF17	CAPI_I2C_SCL_1V8	IO_L1P_T0L_N0_DBC_64	1.8 (LVCMOS18)
BF16	CAPI_I2C_SDA_1V8	IO_L1N_T0L_N1_DBC_64	1.8 (LVCMOS18)
BF19	CAPI_INT/RESET_1V8	IO_L2P_T0L_N2_64	1.8 (LVCMOS18)
BF43	CAPI_RX0_N	MGTYRXN0_124	MGT
BF42	CAPI_RX0_P	MGTYRXP0_124	MGT
BD44	CAPI_RX1_N	MGTYRXN1_124	MGT
BD43	CAPI_RX1_P	MGTYRXP1_124	MGT
BB44	CAPI_RX2_N	MGTYRXN2_124	MGT
BB43	CAPI_RX2_P	MGTYRXP2_124	MGT
AY44	CAPI_RX3_N	MGTYRXN3_124	MGT
AY43	CAPI_RX3_P	MGTYRXP3_124	MGT
BC46	CAPI_RX4_N	MGTYRXN0_125	MGT
BC45	CAPI_RX4_P	MGTYRXP0_125	MGT
BA46	CAPI_RX5_N	MGTYRXN1_125	MGT
BA45	CAPI_RX5_P	MGTYRXP1_125	MGT
AW46	CAPI_RX6_N	MGTYRXN2_125	MGT
AW45	CAPI_RX6_P	MGTYRXP2_125	MGT
AV44	CAPI_RX7_N	MGTYRXN3_125	MGT
AV43	CAPI_RX7_P	MGTYRXP3_125	MGT
AT39	CAPI_TX0_N	MGTYTXN0_124	MGT
AT38	CAPI_TX0_P	MGTYTXP0_124	MGT

Table 9 : Complete Pinout Table (continued on next page)

Pin Number	Signal Name	Pin Name	Bank Voltage
AR41	CAPI_TX1_N	MGTYTXN1_124	MGT
AR40	CAPI_TX1_P	MGTYTXP1_124	MGT
AP39	CAPI_TX2_N	MGTYTXN2_124	MGT
AP38	CAPI_TX2_P	MGTYTXP2_124	MGT
AN41	CAPI_TX3_N	MGTYTXN3_124	MGT
AN40	CAPI_TX3_P	MGTYTXP3_124	MGT
AM39	CAPI_TX4_N	MGTYTXN0_125	MGT
AM38	CAPI_TX4_P	MGTYTXP0_125	MGT
AL41	CAPI_TX5_N	MGTYTXN1_125	MGT
AL40	CAPI_TX5_P	MGTYTXP1_125	MGT
AJ41	CAPI_TX6_N	MGTYTXN2_125	MGT
AJ40	CAPI_TX6_P	MGTYTXP2_125	MGT
AG41	CAPI_TX7_N	MGTYTXN3_125	MGT
AG40	CAPI_TX7_P	MGTYTXP3_125	MGT
AV26	EMCCLK_B	IO_L24P_T3U_N10_EMCCCLK_65	1.8 (LVCMOS18)
BA31	FABRIC_CLK_PIN_N	IO_L13N_T2L_N1_GC_QBC_66	1.8 (LVDS with DIFF_TERM_ADV)
AY31	FABRIC_CLK_PIN_P	IO_L13P_T2L_N0_GC_QBC_66	1.8 (LVDS with DIFF_TERM_ADV)
BA8	FPGA_FLASH_CE0_L	RDWR_FCS_B_0	1.8 (LVCMOS18)
AW24	FPGA_FLASH_CE1_L	IO_L2N_T0L_N3_FWE_FCS2_B_65	1.8 (LVCMOS18)
AW7	FPGA_FLASH_DQ0	D00_MOSI_0	1.8 (LVCMOS18)
AV7	FPGA_FLASH_DQ1	D01_DIN_0	1.8 (LVCMOS18)
AW8	FPGA_FLASH_DQ2	D02_0	1.8 (LVCMOS18)
AV8	FPGA_FLASH_DQ3	D03_0	1.8 (LVCMOS18)
AV28	FPGA_FLASH_DQ4	IO_L22P_T3U_N6_DBC_AD0P-D04_65	1.8 (LVCMOS18)
AW28	FPGA_FLASH_DQ5	IO_L22N_T3U_N7_DBC_AD0N-D05_65	1.8 (LVCMOS18)
BB28	FPGA_FLASH_DQ6	IO_L21P_T3L_N4_AD8P_D06_65	1.8 (LVCMOS18)
BC28	FPGA_FLASH_DQ7	IO_L21N_T3L_N5_AD8N_D07_65	1.8 (LVCMOS18)
BA19	GPIO_0_1V8_N	IO_L13N_T2L_N1_GC_QBC_64	1.8 (LVCMOS18or LVDS)
AY19	GPIO_0_1V8_P	IO_L13P_T2L_N0_GC_QBC_64	1.8 (LVCMOS18or LVDS)
AY20	GPIO_1_1V8_N	IO_L15N_T2L_N5_AD11N_64	1.8 (LVCMOS18or LVDS)
AY21	GPIO_1_1V8_P	IO_L15P_T2L_N4_AD11P_64	1.8 (LVCMOS18or LVDS)
AW20	GPIO_2_1V8_N	IO_L16N_T2U_N7_QBC_AD3N_64	1.8 (LVCMOS18or LVDS)
AV20	GPIO_2_1V8_P	IO_L16P_T2U_N6_QBC_AD3P_64	1.8 (LVCMOS18or LVDS)

Table 9 : Complete Pinout Table (continued on next page)

Pin Number	Signal Name	Pin Name	Bank Voltage
AW18	GPIO_3_1V8_N	IO_L17N_T2U_N9_AD10N_64	1.8 (LVCMOS18or LVDS)
AW19	GPIO_3_1V8_P	IO_L17P_T2U_N8_AD10P_64	1.8 (LVCMOS18or LVDS)
BA27	IBM_PERST_1V8_L	IO_L20P_T3L_N2_AD1P_D08_65	1.8 (LVCMOS18)
BA18	ISO_CLK_1V8	IO_L14P_T2L_N2_GC_64	1.8 (LVCMOS18)
AD8	PCIE_LCL_REFCLK_PIN_N	MGTREFCLK0N_226	MGT REFCLK
AD9	PCIE_LCL_REFCLK_PIN_P	MGTREFCLK0P_226	MGT REFCLK
AF8	PCIE_REFCLK_1_PIN_N	MGTREFCLK0N_225	MGT REFCLK
AF9	PCIE_REFCLK_1_PIN_P	MGTREFCLK0P_225	MGT REFCLK
AB8	PCIE_REFCLK_2_PIN_N	MGTREFCLK0N_227	MGT REFCLK
AB9	PCIE_REFCLK_2_PIN_P	MGTREFCLK0P_227	MGT REFCLK
AL1	PCIE_RX0_N	MGTYRXN3_227	MGT
AL2	PCIE_RX0_P	MGTYRXP3_227	MGT
AM3	PCIE_RX1_N	MGTYRXN2_227	MGT
AM4	PCIE_RX1_P	MGTYRXP2_227	MGT
BA1	PCIE_RX10_N	MGTYRXN1_225	MGT
BA2	PCIE_RX10_P	MGTYRXP1_225	MGT
BC1	PCIE_RX11_N	MGTYRXN0_225	MGT
BC2	PCIE_RX11_P	MGTYRXP0_225	MGT
AY3	PCIE_RX12_N	MGTYRXN3_224	MGT
AY4	PCIE_RX12_P	MGTYRXP3_224	MGT
BB3	PCIE_RX13_N	MGTYRXN2_224	MGT
BB4	PCIE_RX13_P	MGTYRXP2_224	MGT
BD3	PCIE_RX14_N	MGTYRXN1_224	MGT
BD4	PCIE_RX14_P	MGTYRXP1_224	MGT
BE5	PCIE_RX15_N	MGTYRXN0_224	MGT
BE6	PCIE_RX15_P	MGTYRXP0_224	MGT
AK3	PCIE_RX2_N	MGTYRXN1_227	MGT
AK4	PCIE_RX2_P	MGTYRXP1_227	MGT
AN1	PCIE_RX3_N	MGTYRXN0_227	MGT
AN2	PCIE_RX3_P	MGTYRXP0_227	MGT
AP3	PCIE_RX4_N	MGTYRXN3_226	MGT
AP4	PCIE_RX4_P	MGTYRXP3_226	MGT
AR1	PCIE_RX5_N	MGTYRXN2_226	MGT
AR2	PCIE_RX5_P	MGTYRXP2_226	MGT
AT3	PCIE_RX6_N	MGTYRXN1_226	MGT
AT4	PCIE_RX6_P	MGTYRXP1_226	MGT

Table 9 : Complete Pinout Table (continued on next page)

Pin Number	Signal Name	Pin Name	Bank Voltage
AU1	PCIE_RX7_N	MGTYRXN0_226	MGT
AU2	PCIE_RX7_P	MGTYRXP0_226	MGT
AV3	PCIE_RX8_N	MGTYRXN3_225	MGT
AV4	PCIE_RX8_P	MGTYRXP3_225	MGT
AW1	PCIE_RX9_N	MGTYRXN2_225	MGT
AW2	PCIE_RX9_P	MGTYRXP2_225	MGT
Y4	PCIE_TX0_PIN_N	MGTYTXN3_227	MGT
Y5	PCIE_TX0_PIN_P	MGTYTXP3_227	MGT
AA6	PCIE_TX1_PIN_N	MGTYTXN2_227	MGT
AA7	PCIE_TX1_PIN_P	MGTYTXP2_227	MGT
AL6	PCIE_TX10_PIN_N	MGTYTXN1_225	MGT
AL7	PCIE_TX10_PIN_P	MGTYTXP1_225	MGT
AM8	PCIE_TX11_PIN_N	MGTYTXN0_225	MGT
AM9	PCIE_TX11_PIN_P	MGTYTXP0_225	MGT
AN6	PCIE_TX12_PIN_N	MGTYTXN3_224	MGT
AN7	PCIE_TX12_PIN_P	MGTYTXP3_224	MGT
AP8	PCIE_TX13_PIN_N	MGTYTXN2_224	MGT
AP9	PCIE_TX13_PIN_P	MGTYTXP2_224	MGT
AR6	PCIE_TX14_PIN_N	MGTYTXN1_224	MGT
AR7	PCIE_TX14_PIN_P	MGTYTXP1_224	MGT
AT8	PCIE_TX15_PIN_N	MGTYTXN0_224	MGT
AT9	PCIE_TX15_PIN_P	MGTYTXP0_224	MGT
AB4	PCIE_TX2_PIN_N	MGTYTXN1_227	MGT
AB5	PCIE_TX2_PIN_P	MGTYTXP1_227	MGT
AC6	PCIE_TX3_PIN_N	MGTYTXN0_227	MGT
AC7	PCIE_TX3_PIN_P	MGTYTXP0_227	MGT
AD4	PCIE_TX4_PIN_N	MGTYTXN3_226	MGT
AD5	PCIE_TX4_PIN_P	MGTYTXP3_226	MGT
AF4	PCIE_TX5_PIN_N	MGTYTXN2_226	MGT
AF5	PCIE_TX5_PIN_P	MGTYTXP2_226	MGT
AE6	PCIE_TX6_PIN_N	MGTYTXN1_226	MGT
AE7	PCIE_TX6_PIN_P	MGTYTXP1_226	MGT
AH4	PCIE_TX7_PIN_N	MGTYTXN0_226	MGT
AH5	PCIE_TX7_PIN_P	MGTYTXP0_226	MGT
AG6	PCIE_TX8_PIN_N	MGTYTXN3_225	MGT
AG7	PCIE_TX8_PIN_P	MGTYTXP3_225	MGT

Table 9 : Complete Pinout Table (continued on next page)

Pin Number	Signal Name	Pin Name	Bank Voltage
AJ6	PCIE_TX9_PIN_N	MGTYTXN2_225	MGT
AJ7	PCIE_TX9_PIN_P	MGTYTXP2_225	MGT
AW27	PERST0_1V8_L	IO_T3U_N12_PERSTN0_65	1.8 (LVCMOS18)
AY27	PERST1_1V8_L	IO_L23N_T3U_N9_PERSTN1_I-2C_SDA_65	1.8 (LVCMOS18)
AD39	QSFP_CLK_PIN_N	MGTREFCLK0N_126	MGT REFCLK
AD38	QSFP_CLK_PIN_P	MGTREFCLK0P_126	MGT REFCLK
AV16	QSFP_INT_1V8_L	IO_L24P_T3U_N10_64	1.8 (LVCMOS18)
BA14	QSFP_MODPRS_L	IO_L22N_T3U_N7_DBC_AD0N_64	1.8 (LVCMOS18)
AV15	QSFP_RST_1V8_L	IO_L24N_T3U_N11_64	1.8 (LVCMOS18)
AU46	QSFP_RX0_N	MGTYRXN0_126	MGT
AU45	QSFP_RX0_P	MGTYRXP0_126	MGT
AT44	QSFP_RX1_N	MGTYRXN1_126	MGT
AT43	QSFP_RX1_P	MGTYRXP1_126	MGT
AR46	QSFP_RX2_N	MGTYRXN2_126	MGT
AR45	QSFP_RX2_P	MGTYRXP2_126	MGT
AP44	QSFP_RX3_N	MGTYRXN3_126	MGT
AP43	QSFP_RX3_P	MGTYRXP3_126	MGT
AN46	QSFP_RX4_N	MGTYRXN0_127	MGT
AN45	QSFP_RX4_P	MGTYRXP0_127	MGT
AK44	QSFP_RX5_N	MGTYRXN1_127	MGT
AK43	QSFP_RX5_P	MGTYRXP1_127	MGT
AM44	QSFP_RX6_N	MGTYRXN2_127	MGT
AM43	QSFP_RX6_P	MGTYRXP2_127	MGT
AL46	QSFP_RX7_N	MGTYRXN3_127	MGT
AL45	QSFP_RX7_P	MGTYRXP3_127	MGT
AW15	QSFP_SCL_1V8	IO_L23P_T3U_N8_64	1.8 (LVCMOS18)
AW14	QSFP_SDA_1V8	IO_L23N_T3U_N9_64	1.8 (LVCMOS18)
AH43	QSFP_TX0_N	MGTYTXN0_126	MGT
AH42	QSFP_TX0_P	MGTYTXP0_126	MGT
AE41	QSFP_TX1_N	MGTYTXN1_126	MGT
AE40	QSFP_TX1_P	MGTYTXP1_126	MGT
AF43	QSFP_TX2_N	MGTYTXN2_126	MGT
AF42	QSFP_TX2_P	MGTYTXP2_126	MGT
AD43	QSFP_TX3_N	MGTYTXN3_126	MGT
AD42	QSFP_TX3_P	MGTYTXP3_126	MGT

Table 9 : Complete Pinout Table (continued on next page)

Pin Number	Signal Name	Pin Name	Bank Voltage
AC41	QSFP_TX4_N	MGTYTXN0_127	MGT
AC40	QSFP_TX4_P	MGTYTXP0_127	MGT
AB43	QSFP_TX5_N	MGTYTXN1_127	MGT
AB42	QSFP_TX5_P	MGTYTXP1_127	MGT
AA41	QSFP_TX6_N	MGTYTXN2_127	MGT
AA40	QSFP_TX6_P	MGTYTXP2_127	MGT
Y43	QSFP_TX7_N	MGTYTXN3_127	MGT
Y42	QSFP_TX7_P	MGTYTXP3_127	MGT
AV36	SI5328_1V8_SCL	IO_L24N_T3U_N11_66	1.8 (LVCMOS18)
AV35	SI5328_1V8_SDA	IO_L24P_T3U_N10_66	1.8 (LVCMOS18)
AE37	SI5328_OUT_0_PIN_N	MGTREFCLK1N_125	MGT REFCLK
AE36	SI5328_OUT_0_PIN_P	MGTREFCLK1P_125	MGT REFCLK
AB39	SI5328_OUT_1_PIN_N	MGTREFCLK0N_127	MGT REFCLK
AB38	SI5328_OUT_1_PIN_P	MGTREFCLK0P_127	MGT REFCLK
BB19	SI5328_REFCLK_IN_N	IO_L12N_T1U_N11_GC_64	1.8 (LVDS)
BB20	SI5328_REFCLK_IN_P	IO_L12P_T1U_N10_GC_64	1.8 (LVDS)
AV33	SI5328_RST_1V8_L	IO_L22P_T3U_N6_DBC_AD0P_66	1.8 (LVCMOS18)
BE30	SPARE_SCL	IO_L5N_T0U_N9_AD14N_66	1.8 (LVCMOS18)
BC30	SPARE_SDA	IO_L6P_T0U_N10_AD6P_66	1.8 (LVCMOS18)
BD30	SPARE_WP	IO_L6N_T0U_N11_AD6N_66	1.8 (LVCMOS18)
BE31	SRVC_MD_L_1V8	IO_L3P_T0L_N4_AD15P_66	1.8 (LVCMOS18)
AV32	USER_LED_A0_1V8	IO_L18N_T2U_N11_AD2N_66	1.8 (LVCMOS18)
AW32	USER_LED_A1_1V8	IO_T2U_N12_66	1.8 (LVCMOS18)
AY30	USER_LED_G0_1V8	IO_L17N_T2U_N9_AD10N_66	1.8 (LVCMOS18)
AV31	USER_LED_G1_1V8	IO_L18P_T2U_N10_AD2P_66	1.8 (LVCMOS18)
AW33	USR_SW_0	IO_L22N_T3U_N7_DBC_AD0N_66	1.8 (LVCMOS18)
AY36	USR_SW_1	IO_L23P_T3U_N8_66	1.8 (LVCMOS18)

Table 9 : Complete Pinout Table

Revision History

Date	Revision	Changed By	Nature of Change
24 Sep 2018	1.0	K. Roth	Initial Release
31 Oct 2018	1.1	K. Roth	Updated product images, changed default programable clock frequency for CAPI_CLK_1 to 161MHz
14 Dec 2018	1.2	K. Roth	Updated configuration flash part number, changed wording of gpio description for accuracy, added weight.
24 Oct 2019	1.3	K. Roth	Updated Configuration to remove address map and correct description of memory part capacity.
25 Jan 2022	1.4	K. Roth	Updated Thermal Performance to include thermal efficiency figures and comments about the impact of the shroud, removed references to QSFP0 and QSFP1 from section QSFP-DD and updated 25Gb transceiver part number.
17 Jul 2023	1.5	K. Roth	Added Mechanical Dimensions (PCB only)